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(54) Title: POWDERABLE REACTIVE RESIN COMPOSITIONS (57) Abstract A reactive resin composition, which is a fusible, solid optionally foamable, heat curable, epoxy functional reaction product with a Kofler Heat Bank melting point of not less than 55 °C, formed by mixing together: (A) epoxy resins of epoxy group containing compounds; (B) an amine solidifying system present in insufficient quantities to cause gelation after all the amino hydrogen atoms are consumed by epoxy groups, under the reaction conditions chosen for (A) and (B), and which yields a product with a Kofler Heat Bank melting point of greater than 55 °C and less than 120 °C and melting point stability of at least six months normal workshop temperatures; (C) a hardener system for (A) and the reaction product of (A) and (B) which is different from (B) and remains substantially unreacted under the conditions of reaction chosen for (A) and (B) with (A) and (B) and which is of low reactivity at normal workshop temperatures in the final solid epoxy formulation; optionally, (D) an expanding agent which is of low reactivity under the conditions of reaction chosen for (A) and (B) and which is of low reactivity at normal workshop temperatures in the final solid epoxy formulation; and optionally, (E) other additives that may be required to modify the physical properties of the cured or uncured composition.		